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#### **General Description**

The MAX9504A/MAX9504B 3V/5V, ground-sensing amplifiers with a fixed gain of 6dB provide high output current while consuming only 10nA of current in shutdown mode. The MAX9504A/MAX9504B are ideal for amplifying DC-coupled video inputs from current digital-to-analog converters (DACs). The output can drive two DC-coupled 150 $\Omega$  back-terminated video loads in portable media players, security cameras, and automotive video applications. The MAX9504B features an internal 160mV input offset to prevent output sync tip clipping when the input signal is close to ground.

The MAX9504A/MAX9504B have -3dB large-signal bandwidth of 42MHz and -3dB small-signal bandwidth of 47MHz.

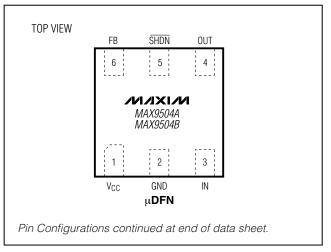
The MAX9504A/MAX9504B operate from a single +2.7V to +5.5V supply and consume only 5mA of supply current. The low-power shutdown mode reduces supply current to 10nA, making the MAX9504A/MAX9504B ideal for low-voltage, battery-powered video applications.

The MAX9504A/MAX9504B are available in tiny 6-pin μDFN (2mm x 2mm) and 6-pin SOT23 packages, and are specified over the -40°C to +85°C extended temperature range.

#### **Applications**

Car Navigation Systems Security Cameras Portable Media Players Low-Power Video Applications Y/C-to-CVBS Mixer

#### **Pin Configurations**



#### Features

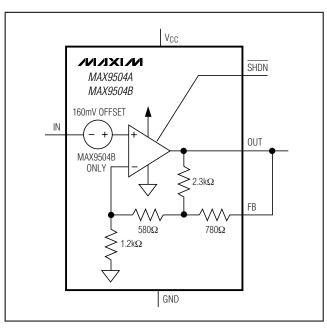
- **♦ DC-Coupled Input/Output**
- ♦ Drives Two DC-Coupled Video Loads
- ◆ Direct Connection to Ground-Referenced DAC
- ♦ 42MHz Large-Signal Bandwidth
- ♦ 47MHz Small-Signal Bandwidth
- ♦ Internal 160mV Input Offset (MAX9504B)
- ♦ Single-Supply Operation from +2.7V to +5.5V
- ♦ 10nA Shutdown Supply Current
- ♦ Small µDFN (2mm x 2mm) and SOT23 Packages

#### **Ordering Information**

PART	PIN- PACKAGE	PKG CODE	OFFSET (mV)	TOP MARK
MAX9504AELT-T	6 μDFN-6	L622-1	0	AAJ
MAX9504AEUT+T	6 SOT23-6	U65-3	0	ABWC
MAX9504BELT-T	6 μDFN-6	L622-1	160	AAK
MAX9504BEUT+	6 SOT23-6	U65-3	160	ABWD

**Note:** All devices specified over the -40°C to +85°C operating

#### **Block Diagram**



NIXIN

Maxim Integrated Products 1

<sup>+</sup>Denotes lead-free package.

#### **ABSOLUTE MAXIMUM RATINGS**

V <sub>CC</sub> to GND	0.3V to +6V
IN, OUT, FB, SHDN to GND	0.3V to (V <sub>CC</sub> + 0.3V)
OUT Short-Circuit Duration to VCC or GNI	
Continuous Power Dissipation (T <sub>A</sub> = +70°	°C)
6-Pin SOT23 (derate 8.7mW/°C above	+70°C)695mW
6-Pin uDEN (derate 4.7mW/°C above +	-70°C) 377mW

Operating Temperature Range .	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10	os)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 3.0V, GND = 0V, V_{IN} = 0.5V, R_L = infinity to GND, FB connected to OUT, $\overline{SHDN} = V_{CC}$, $T_A = -40^{\circ}C$ to +85^{\circ}C$. Typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 1)$ 

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS		
Supply Voltage Range	Vcc	Guaranteed by PSR	2.7		5.5	V			
Quiescent Supply Current	loo	V <sub>C</sub> C = 3V			5	9	mA		
Quiescent Supply Current	Icc	$V_{CC} = 5V$			5	9	IIIA		
Shutdown Supply Current	ISHDN	SHDN = 0V			0.01	1	μΑ		
Input Voltage Range	VIN	Inferred from	MAX9504A	0.10		1.25	V		
Input voltage Hange	VIIV	voltage gain	MAX9504B	0		1.10	V		
Input Offset Voltage	Vos	MAX9504A		-25	0	+25	mV		
Input Onset Voltage	VUS	MAX9504B		120	160	200	1110		
Input Bias Current	IBIAS	$V_{IN} = 0V$			5	20	μΑ		
Input Resistance	R <sub>IN</sub>	0 < V <sub>IN</sub> < 1.45V			4		МΩ		
		$R_L = 150\Omega$ (Note 2), MAX9504A	$V_{CC} = 2.7V,$ $0.1V < V_{IN} < 1.10V$	1.9	2.0	2.1			
			$V_{CC} = 3.0V,$ $0.1V < V_{IN} < 1.25V$	1.9	2.0	2.1			
Naha na Oain			$V_{CC} = 4.5V,$ $0.1V < V_{IN} < 1.90V$		2				
Voltage Gain	Av		V <sub>CC</sub> = 2.7V, 0 < V <sub>IN</sub> < 0.95V	1.9	2.0	2.1	V/V		
				$R_L = 150\Omega$ (Note 2), MAX9504B	V <sub>CC</sub> = 3.0V, 0 < V <sub>IN</sub> < 1.10V	1.9	2.0	2.1	
		WAX95U4B	V <sub>CC</sub> = 4.5V, 0 < V <sub>IN</sub> < 1.75V		2				
Power-Supply Rejection	DODD	0.7\/ .\/	MAX9504A	60	80		٩D		
Ratio	PSRR	$2.7V < V_{CC} < 5.5V$	MAX9504B	50	61		dB		
Output Current	la	Sourcing, $R_L = 20\Omega$	to GND	45	85		A		
Output Current	lout	Sinking, $R_L = 20\Omega$ to	V <sub>CC</sub>	40	110		mA		
Output Short-Circuit Current	Isc	OUT shorted to V <sub>CC</sub> or GND			130		mΑ		
SHDN Logic-Low Threshold	VIL					V <sub>CC</sub> x 0.3	V		
SHDN Logic-High Threshold	V <sub>IH</sub>			V <sub>CC</sub> x 0.7			V		
SHDN Input Current	I <sub>IN</sub>	$\overline{SHDN} = 0V \text{ or } V_{CC}$			0.003	1.000	μΑ		
Shutdown Output Impedance	R <sub>OUT</sub> (Disabled)	SHDN = 0V			4		kΩ		

#### **AC ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = 3.0V, GND = 0V, V_{IN} = 0.5V, R_L = 150\Omega$  to GND, FB connected to OUT,  $\overline{SHDN} = V_{CC}$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)

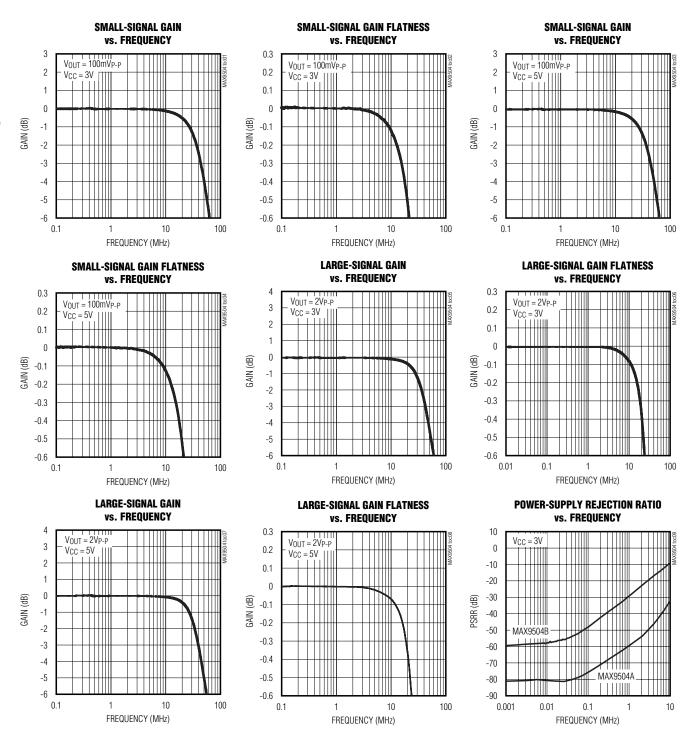
PARAMETER	SYMBOL	CC	ONDITIONS	MIN TYP	MAX	UNITS
Small-Signal -3dB Bandwidth	BWSS	V <sub>OUT</sub> = 100mV <sub>P-P</sub>		47		MHz
Large-Signal -3dB Bandwidth	BWLS	V <sub>OUT</sub> = 2V <sub>P-P</sub>		42		MHz
Small-Signal 0.1dB Gain Flatness	BW <sub>0.1dBSS</sub>	V <sub>OUT</sub> = 100mV <sub>P-F</sub>	0	10		MHz
Large-Signal 0.1dB Gain Flatness	BW <sub>0.1dBLS</sub>	V <sub>OUT</sub> = 2V <sub>P-P</sub>		12		MHz
Slew Rate	SR	V <sub>OUT</sub> = 2V step		165		V/µs
Settling Time to 1%	ts	V <sub>OUT</sub> = 2V step		25		ns
Power-Supply Rejection	PSRR	f = 100kHz	MAX9504A			dB
Ratio	ronn	T = TOOKITZ	MAX9504B	49		ив
Output Impedance	Z <sub>OUT</sub>	f = 5MHz	f = 5MHz			Ω
Differential Oak		NTSC	V <sub>CC</sub> = 3V	0.1		%
Differential Gain	DG	NISC	$V_{CC} = 5V$	0.1		/0
Differential Phase	DP NTSC	NTSC	V <sub>CC</sub> = 3V	0.3		degrees
Dillerential Friase	DF	NISC	$V_{CC} = 5V$	0.3		degrees
2T Pulse-to-Bar K Rating			ime is 18µs, the beginning ling 2.5% of the bar time	0.2		K%
2T Pulse Response		2T = 250ns		0.1		K%
2T Bar Response		2T = 250ns, bar time is 18µs, the beginning 2.5% and the ending 2.5% of the bar time are ignored		0.1		K%
Nonlinearity		5-step staircase		0.1		%
Group Delay Distortion	D/dT	f = 100kHz to 5.5l	MHz	2		ns
Peak Signal-to-RMS Noise	SNR	V <sub>IN</sub> = 1V <sub>P-P</sub> , 100kHz < f < 5MHz		65		dB
Enable Time	ton	V <sub>IN</sub> = 1V, V <sub>OUT</sub> se	ettled to 1% of nominal	300		ns
Disable Time	toff	V <sub>IN</sub> = 1V, V <sub>OUT</sub> se	ettled to 1% of nominal	85		ns

**Note 1:** All devices are 100% production tested at  $T_A = +25$ °C. Specifications over temperature limits are guaranteed by design.

Note 2: Voltage gain (A<sub>V</sub>) is referenced to the input offset voltage; i.e., an input voltage of  $V_{IN}$  would produce an output voltage of  $V_{OUT} = A_V \times (V_{IN} + V_{OS})$ .

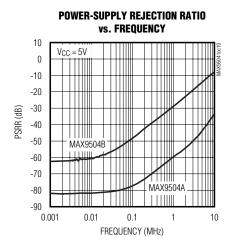
#### **Typical Operating Characteristics**

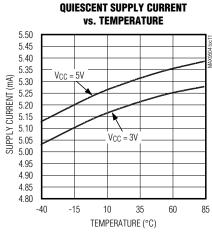
 $(V_{CC} = 3.0V, GND = 0V, V_{IN} = 0.5V, R_L = 150\Omega$  to GND, FB connected to OUT,  $\overline{SHDN} = V_{CC}$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)

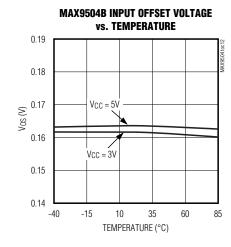


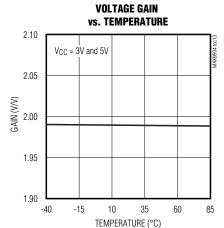
#### Typical Operating Characteristics (continued)

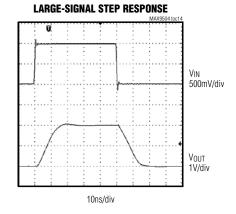
 $(V_{CC} = 3.0V, GND = 0V, V_{IN} = 0.5V, R_L = 150\Omega$  to GND, FB connected to OUT,  $\overline{SHDN} = V_{CC}$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)

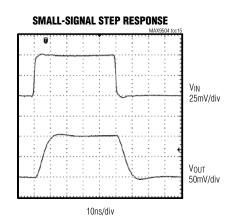


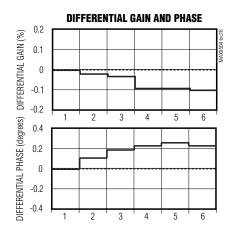






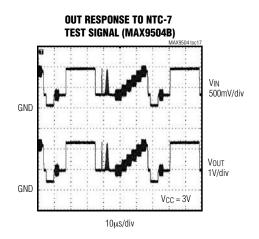


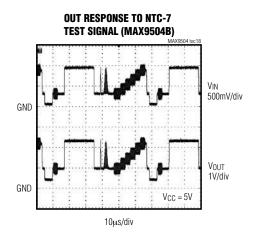


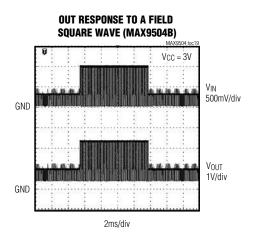


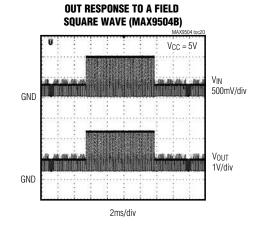
#### Typical Operating Characteristics (continued)

 $(V_{CC} = 3.0V, GND = 0V, V_{IN} = 0.5V, R_L = 150\Omega$  to GND, FB connected to OUT,  $\overline{SHDN} = V_{CC}$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.)





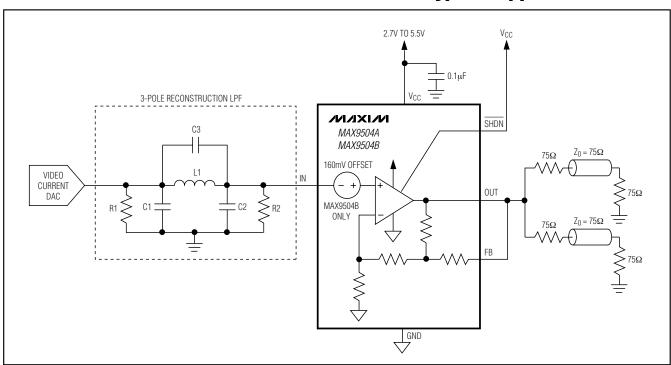




#### **Pin Description**

Р	IN	NAME	FUNCTION	
SOT23	μDFN	NAME	FUNCTION	
1	4	OUT	Video Output	
2	2	GND	Ground	
3	3	IN	Video Input	
4	1	Vcc	Power-Supply Input. Bypass VCC with a 0.1µF capacitor to ground as close as possible to VCC.	
5	5	SHDN	Shutdown Input. Pull SHDN low to place the device in low-power shutdown mode.	
6	6	FB	Feedback. Connect FB to OUT.	

#### **Typical Application Circuit**



#### **Detailed Description**

The MAX9504A/MAX9504B 3V/5V, 6dB video amplifiers with low-power shutdown mode accept DC-coupled inputs and drive up to two DC-coupled, 150 $\Omega$  back-terminated video loads. The MAX9504B provides an internal input offset voltage of 160mV, which allows DC-coupled input signals down to ground without clipping the output sync tip.

The MAX9504A/MAX9504B operate from a single +2.7V to +5.5V supply and consume only 5mA of supply current. The low-power shutdown mode reduces supply current to less than 1µA, making the MAX9504A/MAX9504B ideal for low-voltage, battery-powered video applications.

#### **Output Current Capability**

As shown in the *Typical Application Circuit*, the MAX9504A/MAX9504B can drive up to two  $150\Omega$  loads to ground at the same time because the outputs can source guaranteed 45mA (min) current. Two  $150\Omega$  loads to ground is the same as a single  $75\Omega$  load to ground.

Since the MAX9504A/MAX9504B can also sink guaranteed 40mA (min) current, they can also drive two, AC-coupled 150 $\Omega$  loads. When VCC > 3V, the output can swing 2.4VP-P. When VCC > 4.5V, the output can swing 2.8VP-P.

#### Input Offset (MAX9504B)

The MAX9504A/MAX9504B amplify DC-coupled video signals with a gain of +2V/V (+6dB). The MAX9504B features a 160mV input offset voltage (Vos) that allows a video signal input range to ground without clipping the output sync tip. The MAX9504B output voltage is the sum of the input voltage and the input offset voltage gained up by a factor of 2.

$$V_{OUT} = 2 \times (V_{IN} + V_{OS})$$

For example, if  $V_{IN} = 1V$  and  $V_{OS} = 0.16V$  then:

$$V_{OUT} = 2 \times (1V + 0.16V) = 2.32V$$

#### **Shutdown Mode**

The MAX9504A/MAX9504B feature a low-power shutdown mode (ISHDN < 1 $\mu$ A) for battery-powered/portable applications. Driving SHDN high enables the output. Driving SHDN low disables the output and places the MAX9504A/MAX9504B into a low-power shutdown mode. In shutdown, the output resistance is 4k $\Omega$  (typ) due to the combination of feedback resistors from OUT to ground with FB connected to OUT.

#### **Applications Information**

### Using the MAX9504A/MAX9504B with Video Current DACs

Video current DACs source current into a resistor connected to ground. The output voltage range for composite video and luma (Y) is usually from ground up to 1V (see Figure 1). Notice that the sync tip is quite close to ground. Standard single-supply amplifiers with rail-to-rail outputs have difficulty amplifying input signals at or near ground because their output stages enter a nonlinear mode of operation when the output is pulled close to ground.

The MAX9504B level shifts the input signal up by 160mV so that the output has a positive DC offset of

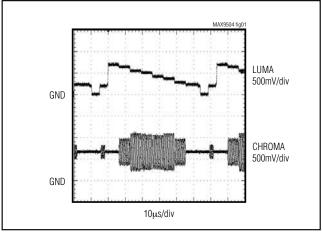


Figure 1. Oscilloscope Trace of Luma and Chroma Signals from Video Current DAC

320mV. As a result, the MAX9504B output stage always operates in the linear mode. Even if the input signal is at ground, the MAX9504B output is at 320mV.

At the output of a video current DAC, the blank level of the chroma signal is usually between 500mV to 650mV. The voltage swing above and below the blank level is approximately ±350mV (see Figure 1). If the blank level is 550mV, then the lowest voltage for the chroma signal is 200mV. For the case of chroma signals, no input level shift is needed because 200mV gained up by two is 400mV, which is well within the linear output range of the MAX9504A or MAX9504B. Since the MAX9504A does not have an input level shift, the MAX9504A should be used with chroma signals. In summary, use the MAX9504B with composite video and luma signals from a DAC, and use the MAX9504A with chroma signals from a DAC.

#### Using the MAX9504A/MAX9504B with a Video Reconstruction Filter

In most video applications, the video signal generated from the DAC requires a reconstruction filter to smooth out the steps and reduce the spikes. The MAX9504 has a high-impedance, DC-coupled input that can be connected directly to the reconstruction filter.

For standard-definition video, the video passband is approximately 6MHz, and the DAC sampling clock is 27MHz. Normally, a 9MHz lowpass filter can be used for the reconstruction filter. This section demonstrates the methods to build simple 2nd- and 3rd-order passive Butterworth lowpass filters with 9MHz cutoff frequency. See Figures 2 and 3.

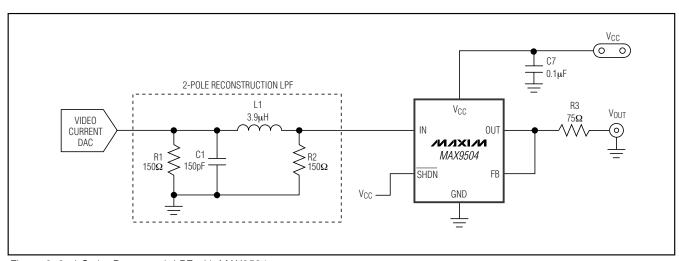


Figure 2. 2nd-Order Butterworth LPF with MAX9504

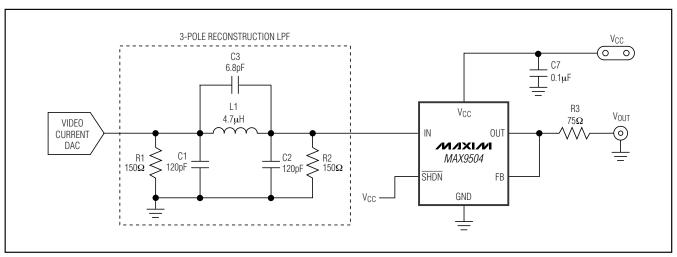


Figure 3. 3rd-Order Butterworth LPF with MAX9504

#### 2nd-Order Butterworth Lowpass Filter Realization

Table 1 shows the normalized 2nd-order Butterworth LPF component values at 1 rad/s with a source/load impedance of  $1\Omega$ .

With the following equations, the L and C can be calculated for the cutoff frequency ( $f_{\rm C}$ ) at 9MHz. Table 2 shows the appropriate L and C values for different source/load impedances, the bench measurement values for the -3dB frequency and the attenuation at 27MHz. There is approximately 20dB attenuation at 27MHz, which decreases the spikes at the sampling frequency.

$$C1 = \frac{Cn1}{2\pi f cR1}$$

$$L1 = \frac{Ln1R1}{2\pi f c}$$

Figure 4 shows the frequency response for R1 = R2 =  $150\Omega$ . At 6MHz, the attenuation is about 1.4dB. The attenuation at 27MHz is about 20dB. Figure 5 shows the multiburst response for R1 = R2 =  $150\Omega$ .

Table 1. 2nd-Order Butterworth Lowpass Filter Normalized Values

$Rn1 = Rn2 (\Omega)$	Cn1 (F)	Ln1 (H)	
1	1.414	1.414	

### Table 2. Bench Measurement Values (2nd-Order LPF)

R1 = R2 (Ω)	C1 (pF)	L1 (µH)	3dB FREQUENCY (MHz)	ATTENUATION AT 27MHz (dB)
75	330	1.8	8.7	20
150	150	3.9	9.0	20
200	120	4.7	9.3	22
300	82	8.2	8.7	20

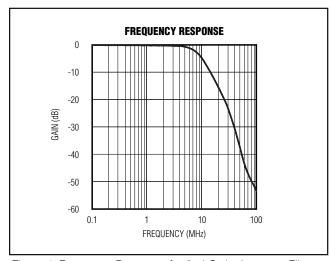


Figure 4. Frequency Response for 2nd-Order Lowpass Filter

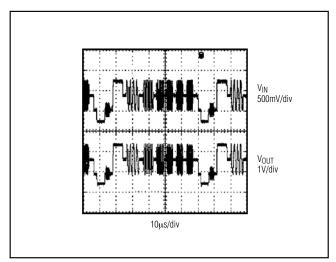


Figure 5. Multiburst Response

#### 3rd-Order Butterworth Lowpass Filter Realization

If a flatter passband and more stopband attenuation are desired, a 3rd-order lowpass filter can be used. The design procedures are similar to the 2nd-order Butterworth lowpass filter.

Table 3 shows the normalized 3rd-order Butterworth lowpass filter with the cutoff frequency at 1 rad/s and the stopband frequency at 3 rad/s. Table 4 shows the appropriate L and C values for different source/load impedances, the bench measurement values for the -3dB frequency and the attenuation at 27MHz. The attenuation is over 40dB at 27MHz. At 6MHz, the attenuation is approximately 0.6dB for R1 = R2 =  $150\Omega$  (Figure 6).

### Table 3. 3rd-Order Butterworth Lowpass Filter Normalized Values

$Rn1 = Rn2$ ( $\Omega$ )	Cn1 (F)	Cn2 (F)	Cn3 (F)	Ln1 (H)
1	0.923	0.923	0.06	1.846

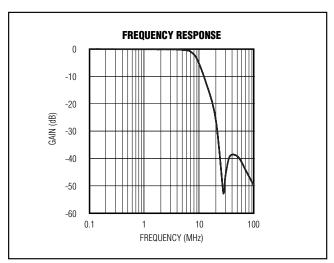


Figure 6. Frequency Response for 3rd-Order Lowpass Filter

#### Y/C-to-Composite Mixer and Driver Circuit

The Y/C-to-composite mixer and driver use two low-pass filters, the MAX9504A and the MAX9504B. In Figure 7, the top video DAC generates a luma signal, which is filtered through the passive RLC network and then amplified by the MAX9504B. The bottom video DAC generates a chroma signal, which is filtered and then amplified by the MAX9504A.

LUMA OUT is directly connected to the output of the MAX9504B through a  $75\Omega$  back-termination resistor; likewise, CHROMA OUT to the output of the MAX9504A. CVBS OUT (the composite video with blanking and sync output) is created by AC-coupling the chroma signal to the luma signal through the 470pF capacitor, which looks like an AC short at the color subcarrier frequency of 3.58MHz for NTSC or 4.43MHz for PAL.

This circuit relies upon the feature that the MAX9504A/MAX9504B can drive two loads at the same time.

Table 4. Bench Measurement Values—3rd Order LPF

$R1 = R2 (\Omega)$	C1 (pF)	C2 (pF)	C3 (pF)	L (µH)	3dB FREQUENCY (MHz)	ATTENUATION AT 27MHz (dB)
75	220	220	15.0	2.2	9.3	43
150	120	120	6.8	4.7	8.9	50
300	56	56	3.3	10.0	9.0	45

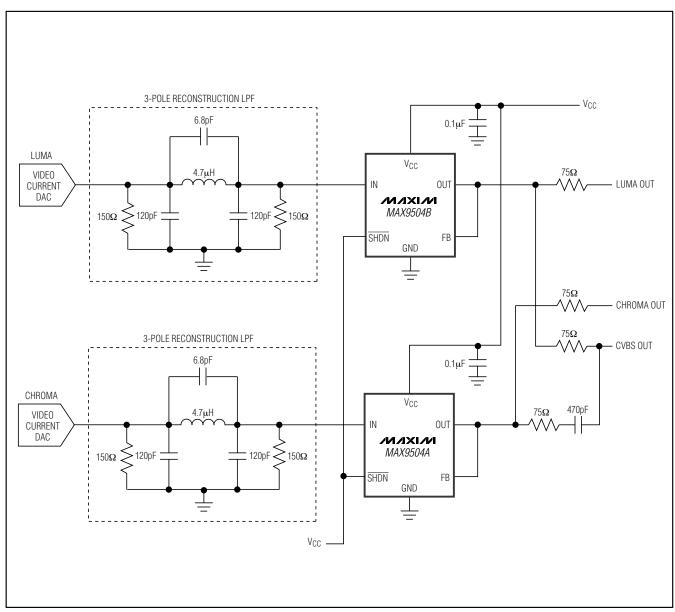


Figure 7. Y/C-to-Composite Mixer and Driver Circuit

#### **AC Output Coupling and Sag Correction**

The MAX9504 can use the sag configuration if the output requires AC-coupling and VCC  $\geq$  4.5V. Sag correction refers to the low-frequency compensation for the highpass filter formed by the 150 $\Omega$  load and the output capacitor. In video applications, the cutoff frequency must be less than 5Hz in order to pass the vertical sync interval and avoid field time distortion (field tilt). In the simplest configuration, a very large coupling capacitor (> 220 $\mu$ F typically) is used to achieve the 5Hz cutoff frequency. In the sag configuration, two smaller capacitors are used to replace the very large coupling capacitor (see Figure 8). For VCC  $\geq$  4.5V, C5 and C6 are 22 $\mu$ C capacitors.

#### **Layout and Power-Supply Bypassing**

The MAX9504A/MAX9504B operate from a single 2.7V to 5.5V supply. Bypass the supply with a 0.1µF capacitor as close to V<sub>CC</sub> possible. Maxim recommends using

microstrip and stripline techniques to obtain full bandwidth. To ensure that the PC board does not degrade the device's performance, design it for a frequency greater than 1GHz. Pay careful attention to inputs and outputs to avoid large parasitic capacitance. Whether or not you use a constant-impedance board, observe the following design guidelines:

- Do not use wire-wrap boards; they are too inductive.
- Do not use IC sockets; they increase parasitic capacitance and inductance.
- Use surface-mount instead of through-hole components for better, high-frequency performance.
- Use a PC board with at least two layers; it should be as free from voids as possible.
- Keep signal lines as short and as straight as possible. Do not make 90° turns; round all corners.

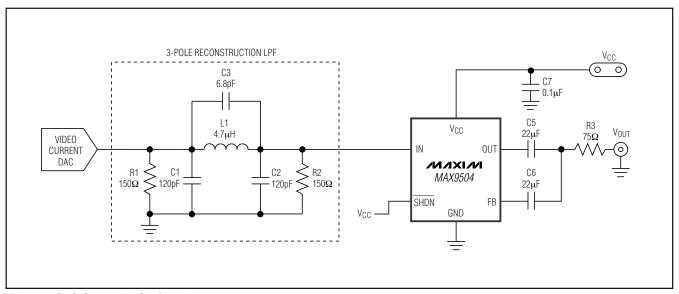
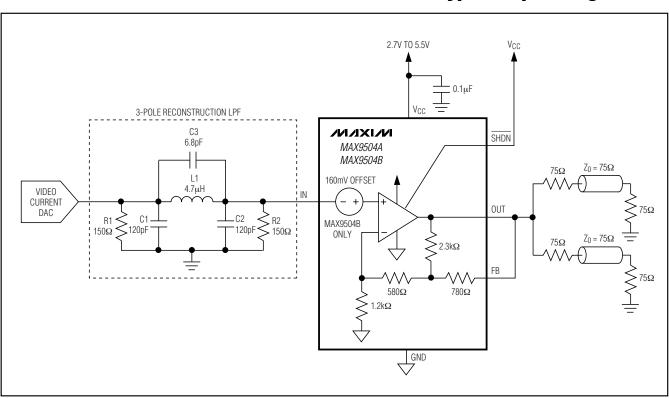


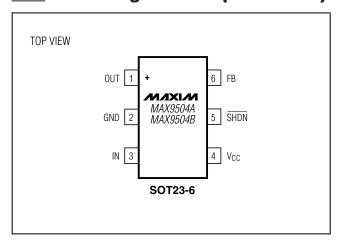
Figure 8. SAG Correction Configuration

### **Typical Operating Circuit**



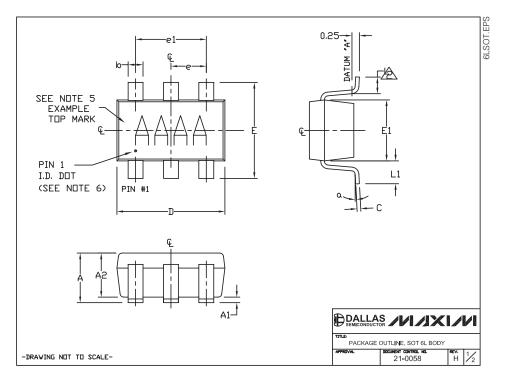
#### **Pin Configurations (continued)**

\_\_\_\_\_Chip Information
PROCESS: BICMOS



#### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



- NOTES:

  1. ALL DIMENSIONS ARE IN MILLIMETERS.

  A FOOT LENGTH MEASURED AT INTERCEPT POINT BETWEEN DATUM A & LEAD SURFACE.

  2. PACKAGE DUTLINE EXCLUSIVE OF MOLD FLASH & METAL BURR. MOLD FLASH, PROTRUSION OR METAL BURR SHOULD NOT EXCEED 0.25 MM.

  4. PACKAGE DUTLINE INCLUSIVE OF SOLDER PLATING.

  5. PIN 1 IS LOWER LEFT PIN WHEN READING TOP MARK FROM LEFT TO RIGHT. (SEE EXAMPLE TOP MARK)

  6. PIN 1 I.D. DOT IS 0.3 MM Ø MIN. LOCATED ABOVE PIN 1.

  7. MEETS JEDEC MOI78, VARIATION AB.

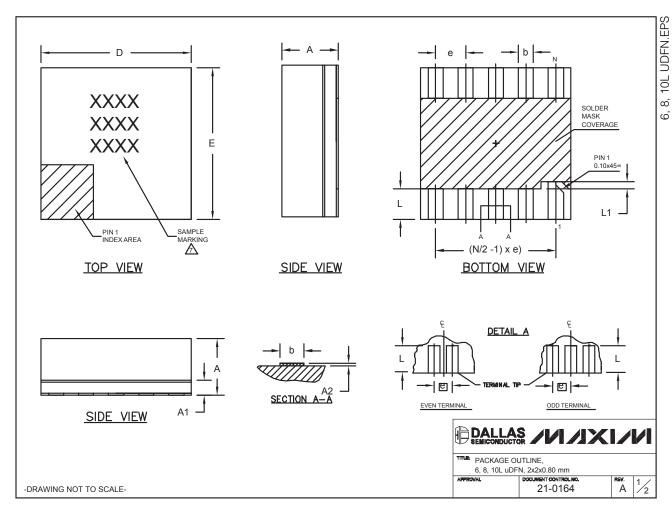
  8. SOLDER THICKNESS MEASURED AT FLAT SECTION OF LEAD BETWEEN 0.08mm AND 0.15mm FROM LEADTIP.

  9. I FAD TO BE COPI ANAR WITHIN 0.1 MM.

SYMBOL	MIN	NDMINAL	MAX		
Α	0.90	1.25	1.45		
A1	0.00	0.05	0.15		
A2	0.90	1.10	1.30		
b	0.35	0.40	0.50		
C	0.08	0.15	0.20		
D	2.80	2.90	3.00		
EJ	2.60	2.80	3.00		
E1	1.50	1.625	1.75		
L	0.35	0.45	0.60		
L1	0.60 REF.				
- 4	100 000				

#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)



#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

COMMON DIMENSIONS							
SYMBOL	MIN.	MIN. NOM. MAX.					
Α	0.70	0.75	0.80				
A1	0.15	0.20	0.25				
A2	0.020	0.025	0.035				
D	1.95	2.00	2.05				
Е	1.95	2.00	2.05				
L	0.30 0.40 0.50						
L1	0.10 REF.						

PACKAGE VARIATIONS				
PKG. CODE	N	е	b	(N/2 -1) x e
L622-1	6	0.65 BSC	0.30±0.05	1.30 REF.
L822-1	8	0.50 BSC	0.25±0.05	1.50 REF.
L1022-1	10	0.40 BSC	0.20±0.03	1.60 REF.

#### NOTES:

- 1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.
  2. COPLANARITY SHALL NOT EXCEED 0.08mm.
- 3. WARPAGE SHALL NOT EXCEED 0.10mm.
- 4. PACKAGE LENGTH/PACKAGE WIDTH ARE CONSIDERED AS SPECIAL CHARACTERISTIC(S).
- "N" IS THE TOTAL NUMBER OF LEADS.
  NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY. 6. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.

  MARKING IS FOR PACKAGE DRIENTATION REFERENCE ONLY.

-DRAWING NOT TO SCALE-



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